



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
01	20	0.4Ω @ V _{GS} = 10V	0.8A
Q1	Q1 30	0.7Ω @ V _{GS} = 4.5V	0.62A
		0.9Ω @ V _{GS} = -10V	-0.55A
Q2	-30	1.7Ω @ V _{GS} = -4.5V	-0.4A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor controls
- Power management functions
- DC-DC converters

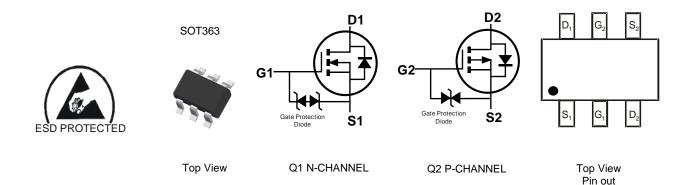
Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT363
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.027 grams (Approximate)



Ordering Information (Note 4)

Notes:

Part Number	Paakaga	Packing		
Fait Nulliper	Package	Qty.	Carrier	
DMC3401LDW-7	SOT363	3000	Tape & Reel	
DMC3401LDW-13	SOT363	10000	Tape & Reel	

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

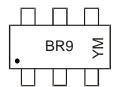
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



 $\begin{array}{l} BR9 = Product \ Type \ Marking \ Code \\ YM = Date \ Code \ Marking \\ Y \ or \ \overline{Y} \ or \ \underline{Y} = Year \ (ex: \ J = 2022) \\ M = Month \ (ex: \ 9 = September) \end{array}$

Date Code Key

Year	2018		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	F		J	K	L	М	Ν	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value_Q1	Value_Q2	Unit		
Drain-Source Voltage			VDSS	30	-30	V
Gate-Source Voltage			Vgss	±20	±20	V
Continuous Drain Current (Note 6) Q1: $V_{GS} = 10V$ Q2: $V_{GS} = -10V$	Steady State	T _A = +25°C T _A = +70°C	ID	0.8 0.6	-0.55 -0.44	A
Maximum Continuous Body Diode Forward Curren	ls	0.4	-0.38	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)		I _{DM}	4	-2.4	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.29	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	433	°C/W
Total Power Dissipation (Note 6)		PD	0.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	301	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics – N Channel – Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	1 2					
Drain-Source Breakdown Voltage	BVDSS	30	—	—	V	V _{GS} = 0V, I _D = 250µA
Zero Gate Voltage Drain Current	IDSS	—	—	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	lgss	—	—	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	0.8	1.2	1.6	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	Descent	—	0.2	0.4	Ω	VGS = 10V, ID = 0.59A
Static Drain-Source On-Resistance	RDS(ON)	—	0.3	0.7	Ω	V _{GS} = 4.5V, I _D = 0.2A
Diode Forward Voltage	Vsd	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 0.1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		50	—	pF	
Output Capacitance	Coss	_	12	—	pF	VDS = 15V, VGS = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	10	_	pF	1 = 1:00012
Gate Resistance	Rg	_	58	—	Ω	$V_{DS} = V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	0.5	—	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	1.2	—	nC	V _{DS} = 10V, I _D = 250mA
Gate-Source Charge	Qgs	—	0.2	—	nC	VDS = 10V, ID = 250IIIA
Gate-Drain Charge	Q _{gd}	—	0.1	—	nC	
Turn-On Delay Time	tD(ON)	—	3.5	—	ns	
Turn-On Rise Time	tR	_	3.3	—	ns	Vgs = 10V, Vds = 30V,
Turn-Off Delay Time	t _{D(OFF)}		16.8	—	ns	$I_{D} = 100 \text{mA}, R_{G} = 25 \Omega$
Turn-Off Fall Time	tF		13.8	_	ns	7

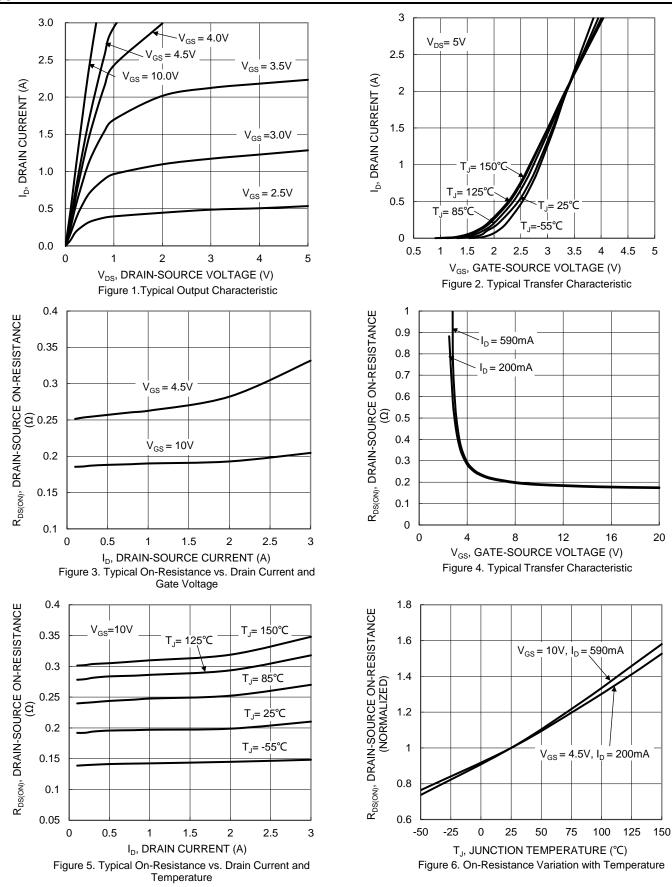
Electrical Characteristics – P Channel – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	—	_	V	$V_{GS} = 0V, I_{D} = -250 \mu A$
Zero Gate Voltage Drain Current	IDSS	—	—	-1	μA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-1	-2.2	-2.6	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance		_	0.5	0.9	Ω	V _{GS} = -10V, I _D = -0.42A
Static Drain-Source On-Resistance	Rds(on)	—	0.78	1.7	12	$V_{GS} = -4.5V, I_{D} = -0.2A$
Diode Forward Voltage	V _{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -0.23A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		19		pF	
Output Capacitance	Coss	—	16	—	pF	VDS = -15V, VGS = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	3	—	pF	1 = 1:000112
Gate Resistance	Rg	—	729	—	Ω	$V_{DS} = V_{GS} = 0V$, f = 1.0MHz
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	0.36	—	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	_	0.8	_	nC	
Gate-Source Charge	Qgs	_	0.1	_	nC	$V_{DS} = -10V, I_{D} = -0.24A$
Gate-Drain Charge	Q _{gd}	_	0.1	_	nC	
Turn-On Delay Time	tD(ON)		30		ns	
Turn-On Rise Time	tR	_	74	_	ns	Vgs = -10V, Vdd = -15V,
Turn-Off Delay Time	t _{D(OFF)}		28		ns	$I_{D} = -0.5A, R_{G} = 1\Omega$
Turn-Off Fall Time	tF		31		ns]

 7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing. Notes:



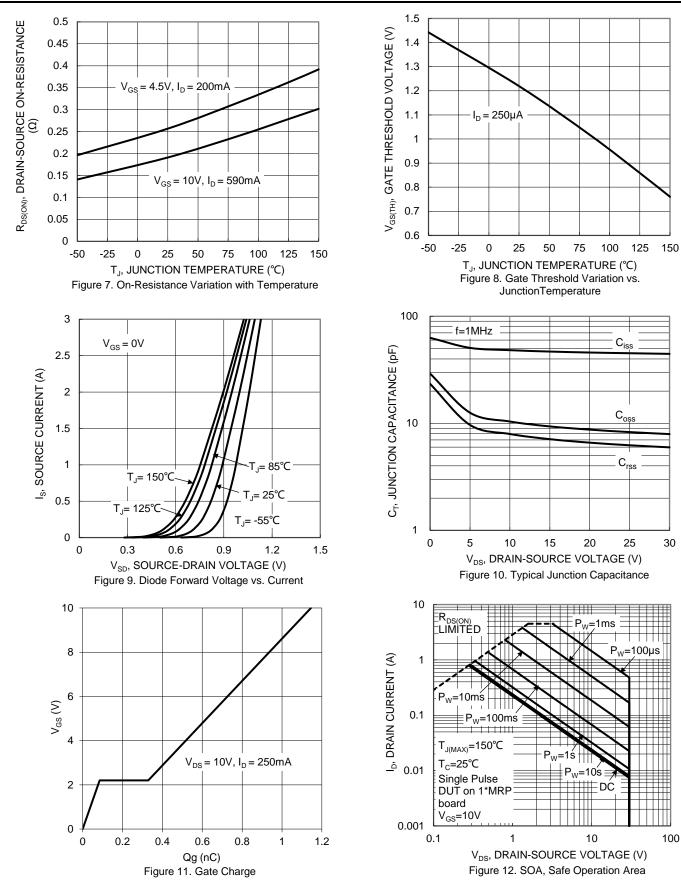
Typical Characteristics - N-CHANNEL



DMC3401LDW Document number: DS41190 Rev. 5 - 2



Typical Characteristics - N-CHANNEL (continued)



DMC3401LDW Document number: DS41190 Rev. 5 - 2

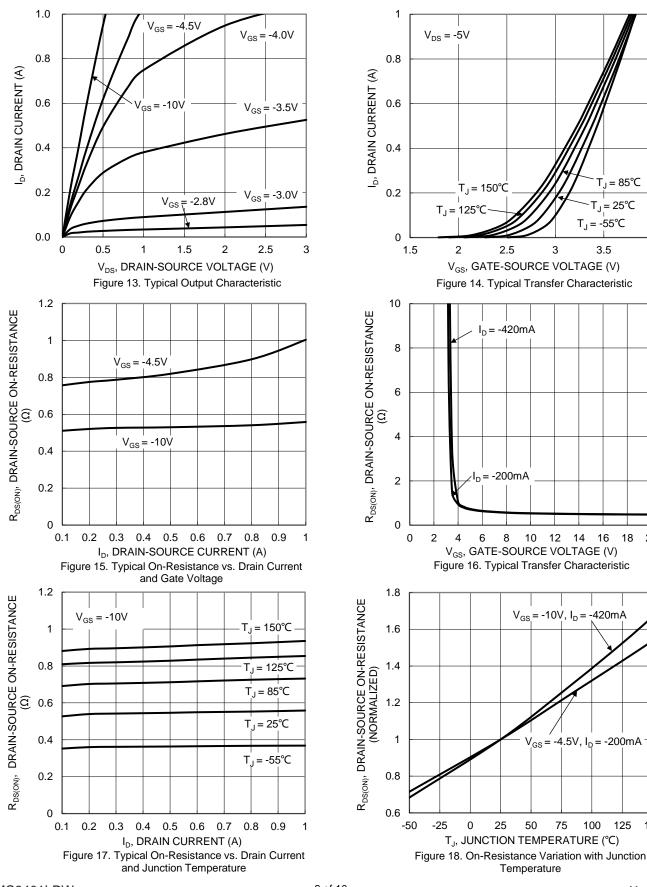


4

20

150

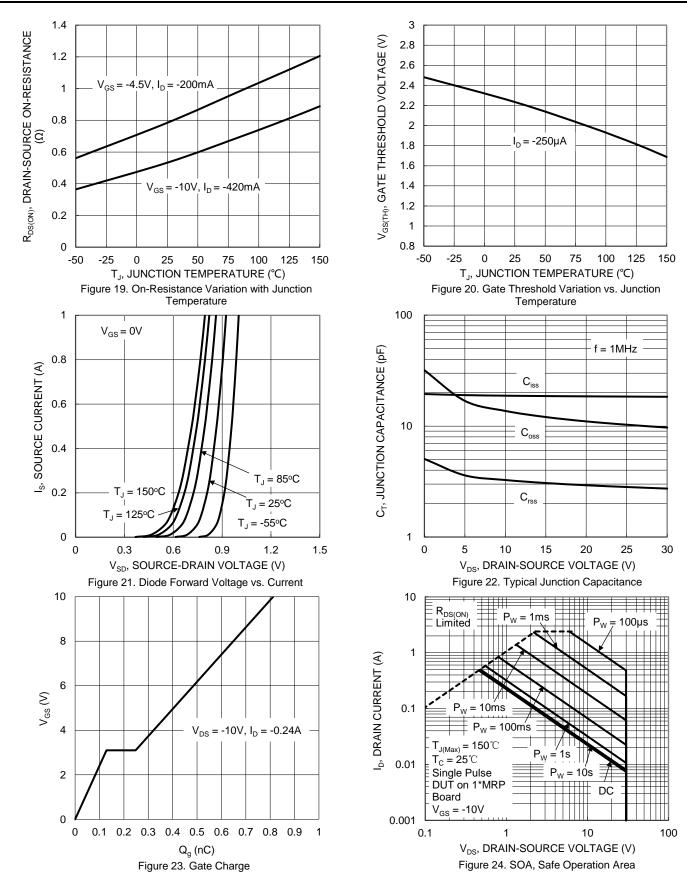
Typical Characteristics - P-CHANNEL



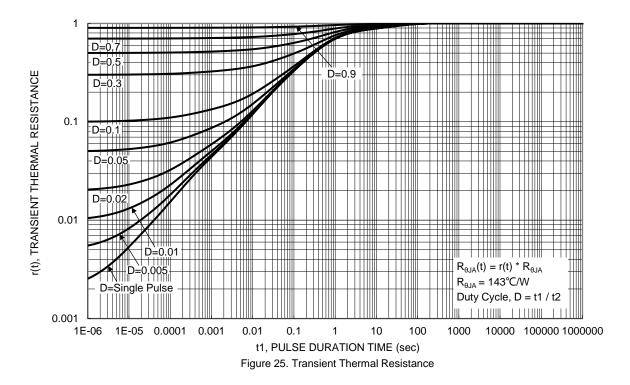
DMC3401LDW Document number: DS41190 Rev. 5 - 2 6 of 10 www.diodes.com



Typical Characteristics - P-CHANNEL (continued)



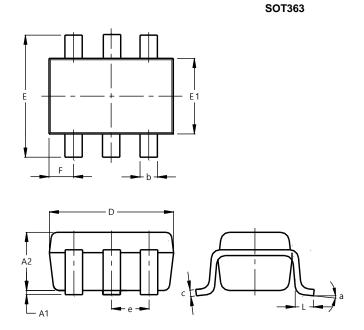






Package Outline Dimensions

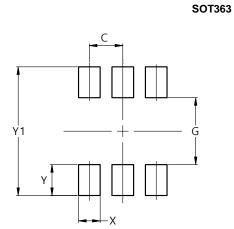
Please see http://www.diodes.com/package-outlines.html for the latest version.



0.07000								
SOT363								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
C	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C).650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All I	Dimen	sions	in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500



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